P-Channel Enhancement-Mode Vertical DMOS FETs

Ordering Information

BV_{DSS} / BV_{DGS}	$R_{DS(ON)}$ (max)	$I_{D(ON)}$ (min)	Order Number / Package
			TO-92
-500V	125Ω	-100mA	VP0550N3

Features

- ❏ Free from secondary breakdown
- ❏ Low power drive requirement
- ❏ Ease of paralleling
- ❏ Low C_{ISS} and fast switching speeds
- ❏ Excellent thermal stability
- ❏ Integral Source-Drain diode
- ❏ High input impedance and high gain
- ❏ Complementary N- and P-channel devices

Applications

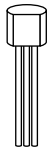
- ❏ Motor controls
- ❏ Converters
- ❏ Amplifiers
- ❏ Switches
- ❏ Power supply circuits
- ❏ Drivers (relays, hammers, solenoids, lamps, memories, displays, bipolar transistors, etc.)

Advanced DMOS Technology

These enhancement-mode (normally-off) transistors utilize a vertical DMOS structure and Supertex's well-proven silicon-gate manufacturing process. This combination produces devices with the power handling capabilities of bipolar transistors and with the high input impedance and positive temperature coefficient inherent in MOS devices. Characteristic of all MOS structures, these devices are free from thermal runaway and thermally-induced secondary breakdown.

Supertex's vertical DMOS FETs are ideally suited to a wide range of switching and amplifying applications where high breakdown voltage, high input impedance, low input capacitance, and fast switching speeds are desired.

Package Option



S G D

TO-92

Note: See Package Outline section for dimensions.

Absolute Maximum Ratings

Drain-to-Source Voltage	BV_{DSS}
Drain-to-Gate Voltage	BV_{DGS}
Gate-to-Source Voltage	± 20V
Operating and Storage Temperature	-55°C to +150°C
Soldering Temperature*	300°C

* Distance of 1.6 mm from case for 10 seconds.

11/12/01

Thermal Characteristics

Package	I_D (continuous)*	I_D (pulsed)	Power Dissipation @ T_C = 25°C	θ_{jc} °C/W	θ_{ja} °C/W	I_{DR}*	I_{DRM}
TO-92	-54mA	-0.25A	1W	125	170	-54mA	-0.25A

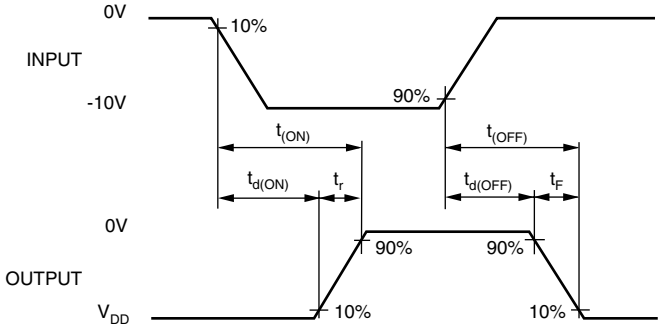
* I_D (continuous) is limited by max rated T_j.

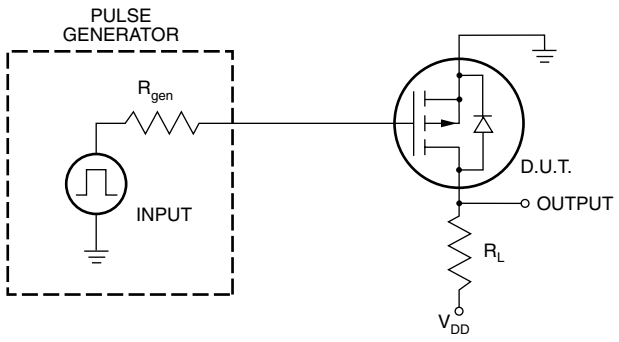
Electrical Characteristics (@ 25°C unless otherwise specified)

Symbol	Parameter	Min	Typ	Max	Unit	Conditions
BV_{DSS}	Drain-to-Source Breakdown Voltage	-500			V	V_{GS} = 0V, I_D = -1mA
$V_{GS(th)}$	Gate Threshold Voltage	-2.0		-4.5	V	V_{GS} = V_{DS}, I_D = -1mA
$\Delta V_{GS(th)}$	Change in $V_{GS(th)}$ with Temperature		3.5	6	mV/°C	V_{GS} = V_{DS}, I_D = -1mA
I_{GSS}	Gate Body Leakage			-100	nA	V_{GS} = ±20V, V_{DS} = 0V
I_{DSS}	Zero Gate Voltage Drain Current			-10	μA	V_{GS} = 0V, V_{DS} = Max Rating
				-1000		V_{GS} = 0V, V_{DS} = 0.8 Max Rating T_A = 125°C
$I_{D(ON)}$	ON-State Drain Current		-90		mA	V_{GS} = -5V, V_{DS} = -25V
		-100	-240			V_{GS} = -10V, V_{DS} = -25V
$R_{DS(ON)}$	Static Drain-to-Source ON-State Resistance		85		Ω	V_{GS} = -5V, I_D = -5mA
			80	125		V_{GS} = -10V, I_D = -10mA
$\Delta R_{DS(ON)}$	Change in $R_{DS(ON)}$ with Temperature		0.85		%/°C	V_{GS} = -10V, I_D = -10mA
G_{FS}	Forward Transconductance	25	40		m℧	V_{DS} = -25V, I_D = -10mA
C_{ISS}	Input Capacitance		40	70	pF	V_{GS} = 0V, V_{DS} = -25V f = 1 MHz
C_{OSS}	Common Source Output Capacitance		10	20		
C_{RSS}	Reverse Transfer Capacitance		3	10		
$t_{d(ON)}$	Turn-ON Delay Time		5	10	ns	V_{DD} = -25V I_D = -100mA R_{GEN} = 25Ω
t_r	Rise Time		8	10		
$t_{d(OFF)}$	Turn-OFF Delay Time		8	15		
t_f	Fall Time		5	16		
V_{SD}	Diode Forward Voltage Drop		-0.8	-1.5	V	V_{GS} = 0V, I_{SD} = -0.1A
t_{rr}	Reverse Recovery Time		200		ns	V_{GS} = 0V, I_{SD} = -0.1A

Notes:
1. All D.C. parameters 100% tested at 25°C unless otherwise stated. (Pulse test: 300μs pulse, 2% duty cycle.)
2. All A.C. parameters sample tested.

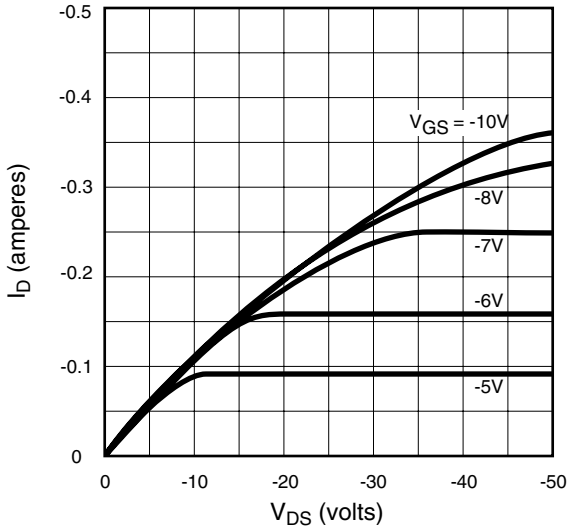
Switching Waveforms and Test Circuit



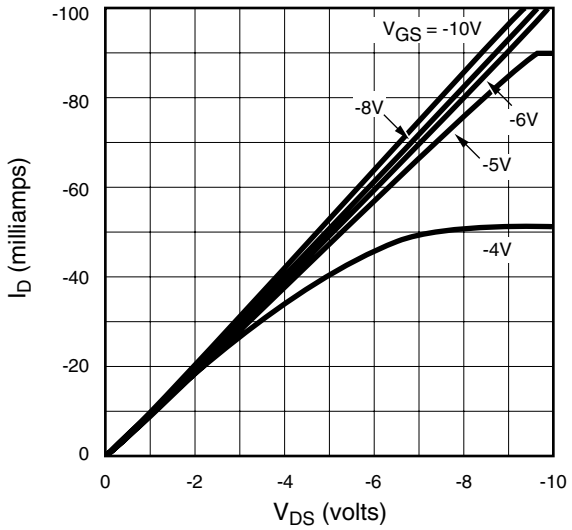


Typical Performance Curves

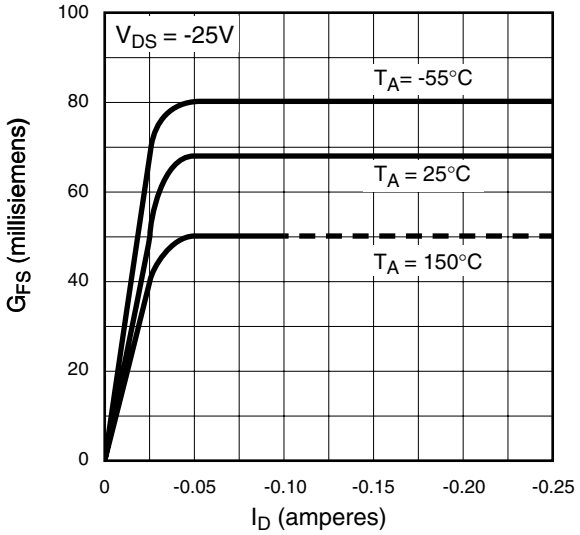
Output Characteristics



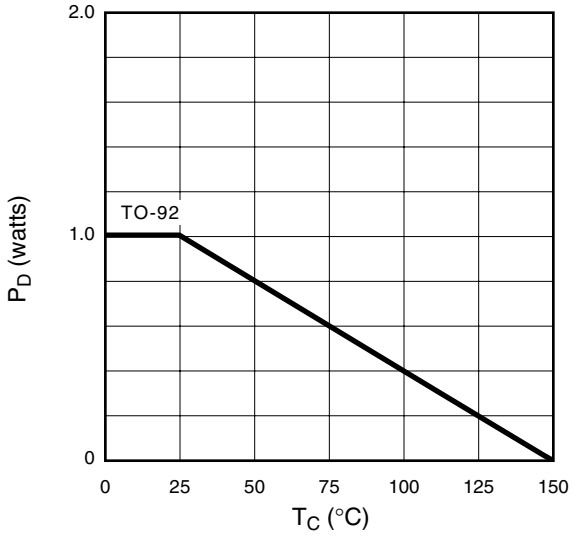
Saturation Characteristics



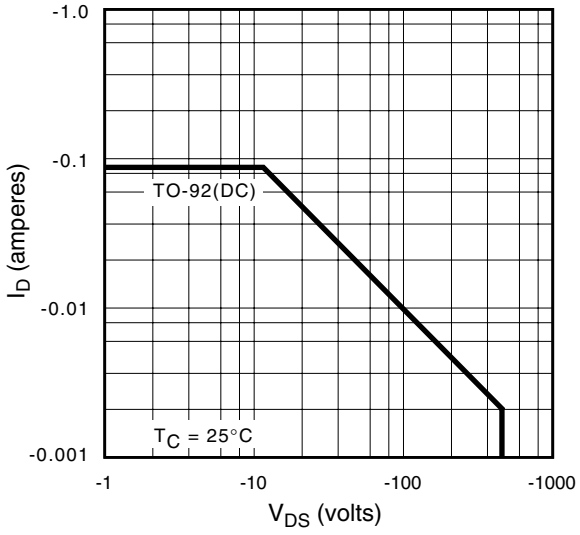
Transconductance vs. Drain Current



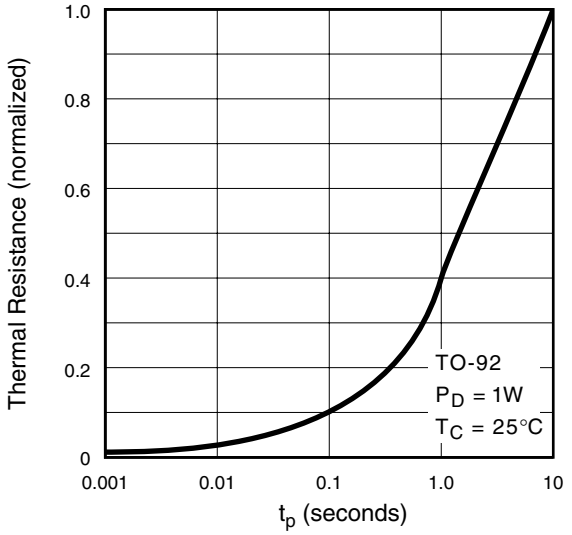
Power Dissipation vs. Case Temperature



Maximum Rated Safe Operating Area

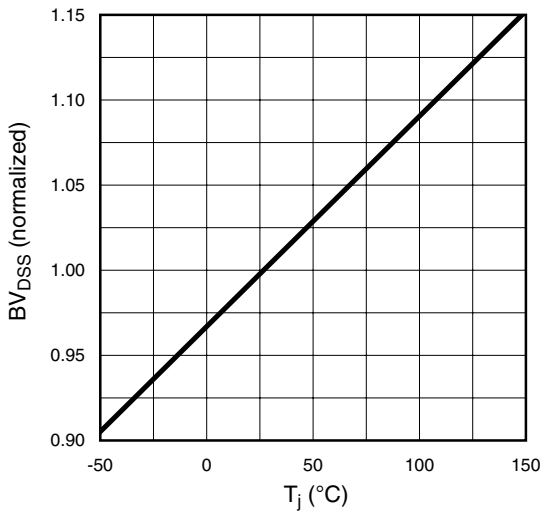


Thermal Response Characteristics

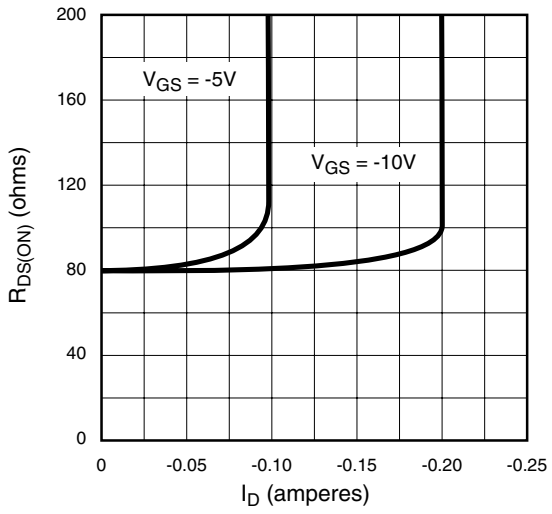


Typical Performance Curves

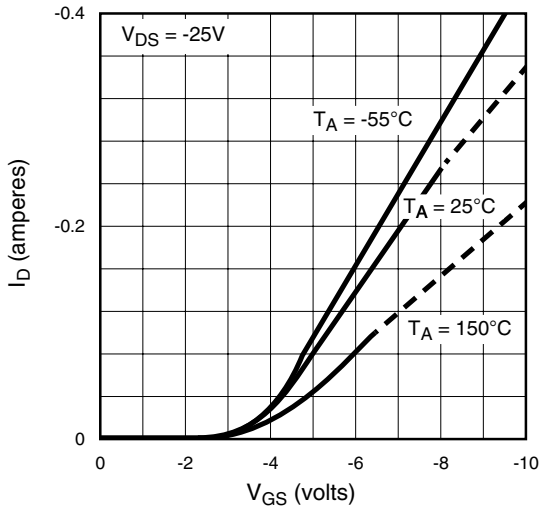
BV_{DSS} Variation with Temperature



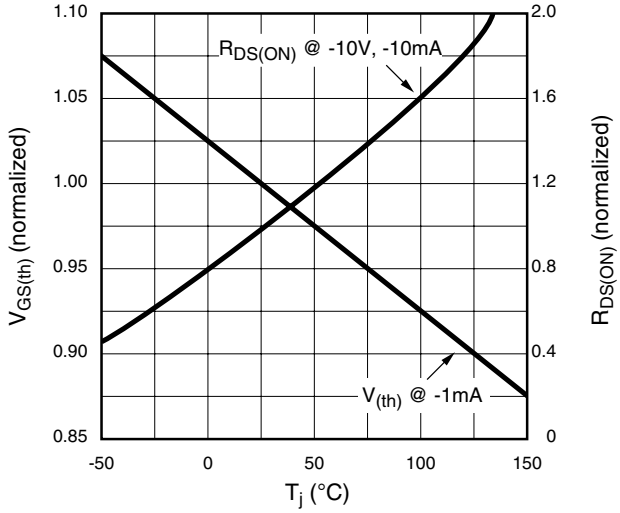
On-Resistance vs. Drain Current



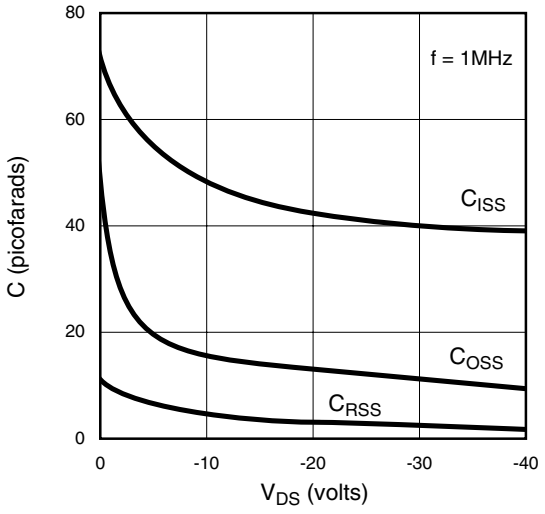
Transfer Characteristics



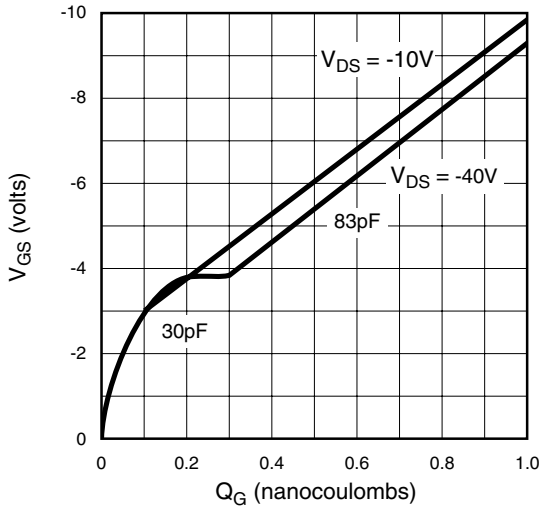
$V_{(th)}$ and R_{DS} Variation with Temperature



Capacitance vs. Drain-to-Source Voltage



Gate Drive Dynamic Characteristics



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